PTO-1449	Application No. 10/649,925	Applicant(s) Kovacevic et al.	
Information Disclosure Citation In an Application	Docket Number 021791.0109	Group Art Unit 2125	Filing Date 08/25/2003

U.S. PATENT DOCUMENTS

		DOCUMENT NO.	DATE	NAME	CLASS	SUBCLASS	FILING DATE
CK	A	6,122,564	09/19/2000	Koch et al.	700	123	06/30/1998
CK	B	6,188,041	02/13/2001	Kim et al.	219	121.63	11/13/1998
CK	C	6,311,099	10/30/2001	Jasper et al.	700	166	10/15/1998
CK	D	6,401,001	06/04/2002	Jang et al.	700	118	07/22/1999
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CK	G	6,638,787	10/28/2003	Buchin et al.	438	75	12/04/2001
CK	H	US 2004/0107019	06/03/2004	Keshavmurthy et al.	700	118	07/18/2003
	I						
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	N						

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		DOCUMENT NO.	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES	TRANSLATION NO
CK	O		07/06/1999	Japan	B23K	26/02	XX	
CK	P	WO 03/070414 A1	08/28/2003	PCT	B23K	26/03	XX	
	Q							

		OTHER DOCUMENTS (Including Author, Title, Source, and Pertinent Pages)	DATE
	R		
	S		
	T		

EXAMINER	DATE CONSIDERED
Chuchi Kaya	3/28/05

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.

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PTO-1449	Application No. 10/649,925	Applicant(s) Kovacevic et al.
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CK	B	6,580,959	06/17/2003	Mazumder	700	121	05/19/2000
	C						

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CK	E	B. Grünenwald et al., "*New Technological Developments in Laser Cladding*", Proceedings of the International Congress on Applications of Lasers and Electro-Optics (ICALEO 1993), pp. 934-944.	1993
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EXAMINER Chakri Kosaraju — DATE CONSIDERED 3/28/05

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